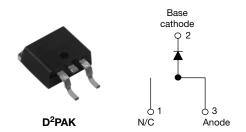




Vishay High Power Products

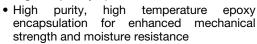
Schottky Rectifier, 8 A



PRODUCT SUMMARY					
I _{F(AV)}	8 A				
V _R	80 V/100 V				

FEATURES

- 175 °C T_{.I} operation
- Low forward voltage drop
- High frequency operation





FREE

- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Halogen-free according to IEC 61249-2-21 definition
- Compliant to RoHS directive 2002/95/EC
- AEC-Q101 qualified

DESCRIPTION

The VS-8TQ... Schottky rectifier series has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 175 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS									
SYMBOL	CHARACTERISTICS	VALUES	UNITS A V A V						
I _{F(AV)}	Rectangular waveform	8	А						
V _{RRM}	Range	80/100	V						
I _{FSM}	t _p = 5 µs sine	850	А						
V _F	8 Apk, T _J = 125 °C	0.58	V						
T _J	Range	- 55 to 175	°C						

VOLTAGE RATINGS									
PARAMETER	SYMBOL	VS-8TQ080GSPbF	UNITS						
Maximum DC reverse voltage	V _R	80	100	V					
Maximum working peak reverse voltage	V_{RWM}	00	100	V					

ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL	TEST CONDI	VALUES	UNITS				
Maximum average forward current See fig. 5	I _{F(AV)}	50 % duty cycle at T _C = 157 °C	8	А				
Maximum peak one cycle non-repetitive surge current	I _{FSM}	5 μs sine or 3 μs rect. pulse	Following any rated	850	· A			
See fig. 7		10 ms sine or 6 ms rect. pulse	rated V _{RRM} applied	230				
Non-repetitive avalanche energy	E _{AS}	$T_J = 25 ^{\circ}\text{C}, I_{AS} = 0.5 \text{A}, L = 60 \text{m}$	7.50	mJ				
Repetitive avalanche current	I _{AR}	Current decaying linearly to zero Frequency limited by T _J maximum	0.5	А				

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VS-8TQ080GSPbF, VS-8TQ100GSPbF

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ELECTRICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CO	VALUES	UNITS				
		8 A	T _{.1} = 25 °C	0.72				
Maximum forward voltage drop		16 A	11 = 23 0	88.0				
See fig. 1	V _{FM} ⁽¹⁾	8 A	T _J = 125 °C	0.58	V			
		16 A	1j = 125 C	0.69				
Maximum reverse leakage current	I _{RM} ⁽¹⁾	T _J = 25 °C	V _R = Rated V _R	0.28	- mA			
See fig. 2		T _J = 125 °C	v _R = nateu v _R	7				
Maximum junction capacitance	C _T	V _R = 5 V _{DC} (test signal range 100 kHz to 1 MHz), 25 °C		500	pF			
Typical series inductance	L _S	Measured lead to lead 5 r	8.0	nH				
Maximum voltage rate of change	dV/dt	Rated V _R	10 000	V/µs				

Note

 $^{^{(1)}\,}$ Pulse width < 300 µs, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum junction and storage temperature range		T _J , T _{Stg}		- 55 to 175	°C			
Maximum thermal resistance, junction to case		R _{thJC}	DC operation See fig. 4		°C/W			
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.50	G/ VV			
Approximate weight				2	g			
Approximate weight				0.07	oz.			
Mounting torque	minimum			6 (5)	kgf · cm			
Mounting torque	maximum			12 (10)	(lbf \cdot in)			
Marking device			Case style D ² PAK	8TQ0	TQ080GS			
			Case style D-FAR	8TQ1	00GS			



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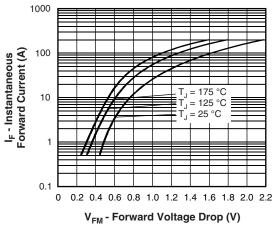


Fig. 1 - Maximum Forward Voltage Drop Characteristics

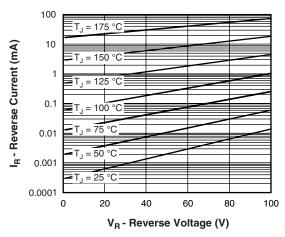


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

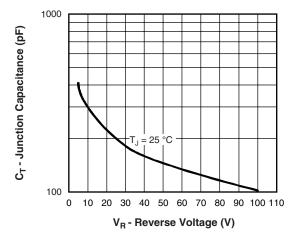


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

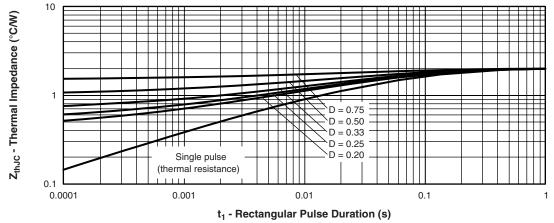


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

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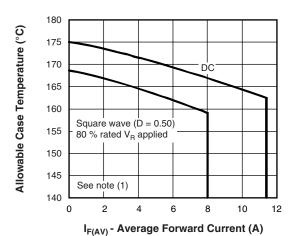


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

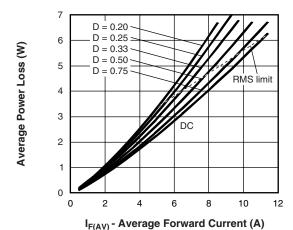


Fig. 6 - Forward Power Loss Characteristics

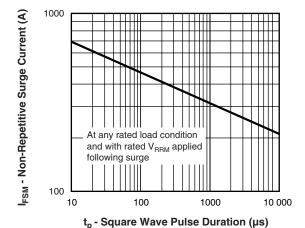


Fig. 7 - Maximum Non-Repetitive Surge Current

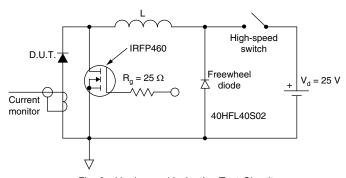


Fig. 8 - Unclamped Inductive Test Circuit

Note

 $^{(1)}$ Formula used: T_C = T_J - (Pd + Pd_{REV}) x R_{thJC}; Pd = Forward power loss = I_{F(AV)} x V_{FM} at (I_{F(AV)}/D) (see fig. 6); Pd_{REV} = Inverse power loss = V_{R1} x I_R (1 - D); I_R at V_{R1} = 80 % rated V_R

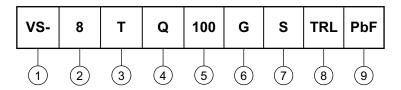


VS-8TQ080GSPbF, VS-8TQ100GSPbF

Schottky Rectifier, 8 A Vishay High Power Products

ORDERING INFORMATION TABLE

Device code



1 - HPP product suffix

2 - Current rating (8 = 8 A)

3 - T = TO-220

4 - Q = Schottky "Q" series

6 - G = Schottky generation

7 - S = D²PAK

None = Tube (50 pieces)

• TRL = Tape and reel (left oriented)

• TRR = Tape and reel (right oriented)

9 - PbF = Lead (Pb)-free

LINKS TO RELATED DOCUMENTS						
Dimensions	www.vishay.com/doc?95046					
Part marking information	www.vishay.com/doc?95058					
Packaging information	www.vishay.com/doc?95032					
SPICE model	www.vishay.com/doc?95291					

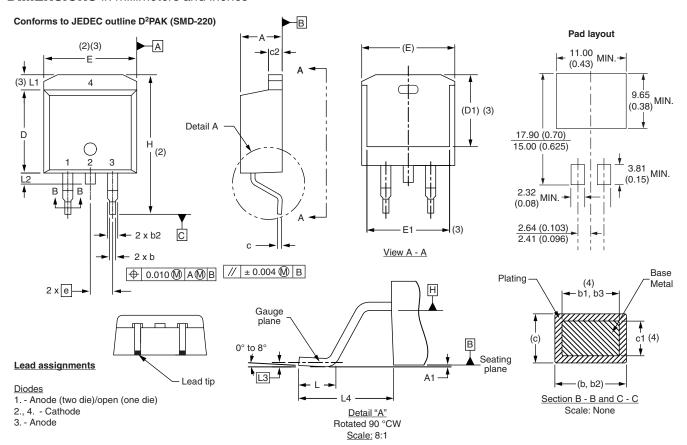
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Vishay Semiconductors

D²PAK

DIMENSIONS in millimeters and inches



CVM	SYMBOL	MILLIM	IETERS	INC	HES	NOTES	NOTES	SYMBOL	MILLIN	IETERS	INC	HES
3110	IBOL	MIN.	MAX.	MIN.	MAX.	NOTES		STINIBUL	MIN.	MAX.	MIN.	MAX.
/	4	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315
Α	\1	0.00	0.254	0.000	0.010			E	9.65	10.67	0.380	0.420
I	b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346
b	1	0.51	0.89	0.020	0.035	4		е	2.54 BSC		0.100 BSC	
b	2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625
b	3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110
(С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066
C	:1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070
C	2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC
1)	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208

Notes

- $^{(1)}$ Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC outline TO-263AB

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NOTES

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2, 3

3

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Legal Disclaimer Notice



Vishay

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Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Revision: 02-Oct-12 Document Number: 91000